



Benefits

- No external trimming components required
- PC-controlled configuration and calibration via one-wire interface – simple, low cost
- High accuracy ($\pm 0.1\%$ FSO @ -25 to 85°C ; $\pm 0.25\%$ FSO @ -40 to 125°C)

The ZMD31035 is a CMOS integrated circuit for highly-accurate amplification and sensor-specific correction of bridge sensor signals. Digital compensation of sensor offset, sensitivity, temperature drift and non-linearity is accomplished via a 16-bit RISC micro-controller running a correction algorithm with calibration coefficients stored in a non-volatile EEPROM.

The ZMD31035 is adjustable to nearly all piezo-resistive bridge sensors. Measured values are provided at the analog voltage output or at the one-wire-interface.

The digital one-wire-interface can be used for a simple PC-controlled calibration procedure, in order to program a set of calibration coefficients into an on-chip EEPROM. Thus a specific sensor and a ZMD31035 are mated digitally: fast, precise and without the cost overhead associated with trimming by external devices or laser. The ZMD31035 is optimized for automotive environments by its protection circuitry and excellent electromagnetic compatibility.

- Evaluation kit will be available, containing PCBs, SSOP14 samples, software, documentation
- Support for industrial mass calibration available
- Quick circuit customization possible for large production volumes

Application Examples

- Detection of low-/overpressure in fuel tanks
- MAP Sensors
- Hydraulic reservoir pressure monitoring for ABS and power steering
- Engine management
- Comfort functions
- Tire pressure monitoring (in combination with wireless transmitters)

Ordering Information

Ordering Code	Description	Operating Temperature Range	Package Type	Device Marking	Shipping Form**
ZMD31035AD ES	engineering samples as dice in waffletray		die		waffle tray
ZMD31035AF ES	engineering samples as finished parts		SSOP14	ZMD 31035AF YYWW ***	sample box or tube
ZMD31035AAB*	dice on tested unsawn wafer	-40°C to +125°C	die		6" wafer
ZMD31035AAC*	dice on tested sawn wafer	-40°C to +125°C	die		sawn 6" wafer on plastic frame
ZMD31035AAD*	dice in waffle tray	-40°C to +125°C	die		waffle tray (100 dice / tray)
ZMD31035AAF-T*	finished parts in tube	-40°C to +125°C	SSOP14	ZMD 31035AAF YYWW	tube (77 parts / tube)
ZMD31035AAF-R*	finished parts in tape on reel	-40°C to +125°C	SSOP14	ZMD 31035AAF YYWW	tube (2000 parts / reel)
ZMD31035KIT	evaluation kit				box with PCBs, CD-ROM, SSOP14 samples

* Serial parts – available from serial production start

** The quantity ordered should be a multiple of the quantity / packing unit as specified

*** Optional labeled with "ES" in addition

For further information:

ZMD AG
Grenzstrasse 28
01109 Dresden
Germany
Tel +49.351.8822.366
Fax +49.351.8822.337
sales@zmd.de

ZMD America, Inc.
201 Old Country Road, Suite 204
Melville, NY 11747
USA
Tel +1.631.549.2666
Fax +1.631.549.2882
sales@zmda.com

ZMD America, Inc.
15373 Innovation Drive, Suite 115
San Diego, CA 92128
USA
Tel +1.858.674.8070
Fax +1.858.674.8071
sales@zmda.com